

Conductive Silicone Paste

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TECHNICAL DATA SHEET

June 2011

Part # MC10-0019-00

| DESCRIPTION | MAST Technologies' conductive silicone paste is a two part silicone paste which is loaded with electrically conductive particles. Conductive silicone paste can be used for loading EMI/EMC shielding, sealing apertures, and maintained conductive surface continuity. MAST Technologies' conductive silicone pastes can be used for prototyping and test or in production via an automated dispensing system. | | |
|-----------------|---|---|--|
| APPEARANCE | Two-part, dispensable, grey RTV silicone | TITT | |
| PART NUMBERING: | MC10-0019-XX 01: 1 Quart Size 03: 8 oz. SEM-KIT® Other sizes available, please contact MAST Technologies. | | |
| OPTIONS | MAST Conductive Silicone Paste comes with a standard volume resistivity of <100 mΩ-cm. Alternate hardness (Shore A) may be achieved by altering the filler loading level. High temperature silicones are also available for applications above 500° F. Contact at MAST engineer for more details. | Injection style Semkit* packages for multi-component adhesives and seelants | |

PHYSICAL PROPERTIES (values shown are under development and intended to be representative only)

| Typical Properties | MC10-0019-XX | |
|----------------------------------|--|--|
| Elastomer | Silicone Paste Elastomer | |
| Description | Two-part, castable liquid silicone RTV | |
| Appearance | Grey | |
| Product Forms | Caulk, Paste | |
| Electrical Properties | <100 mΩ-cm | |
| Hardness (Shore A) | 75 (typical) | |
| Operating Temperature Range | 350°F | |
| Mix Ratio | 35:1 (base/curing agent) | |
| Working Time at Room Temperature | 2 hours | |
| | >48 hours at RT | |
| Personmanded Cure Personators | 35 min at 212°F | |
| Recommended culle Parameters | 20 min at 257°F | |
| | 10 min at 302°F | |

INSTRUCTIONS FOR USE

Mixing

Thoroughly mix just prior to use.

MAST Technologies' Silicone Conductive Paste is supplied in two parts as lot-matched base and curing agent that are mixed in a ratio of 35 parts base to one part curing agent, by weight. After thoroughly mixing base and curing agent, agitate gently to reduce the amount of air introduced. Allowing the mixture to set for 30 minutes before pouring may be adequate for removal of the air introduced during mixing. If air bubbles are still present, vacuum de-gas may be required.

Vacuum Degassing

If you purchase a SEM-KIT, the material will be degassed. However and if required, remove air entrapped during mixing by common vacuum degassing procedure, observing all applicable safety precautions. Slowly apply vacuum, up to 28 inches Hg, to a container rated for use and of volume at least four times that of material being degassed. Hold vacuum until presence of air is no longer evident.

All information on this data sheet is based on laboratory testing and is not intended for design purposes. MAST Technologies makes no representations or warranties of any kind concerning this data. For part number quality assurance specifications, please contact a MAST Technologies technical representative.

